


10/605,369

FIS920030011US1

I hereby certify that this paper and fee are being TRANSMITTED VIA FACSIMILE TO: Assistant Commissioner for Patents, P. O. Box 1450, ALEXANDRIA, VA 22313-1450. Date of Deposit: 06/09/05 Name of Person Making Deposit: Linda Roberts-Jackson

Signature

**In the United States Patent and Trademark Office****Date:** 6/09/05**In re** Lloyd Burrell, et al.**Filed:** 9/25/03**Applicat****ion of:****For:** SEMICONDUCTOR DEVICE HAVING A COMPOSITE  
LAYER IN ADDITION TO A BARRIER LAYER BETWEEN  
COPPER WIRING AND ALUMINUM BOND PAD**Serial** 10/605,369**Confirmation No.****Number**

2368

**:****Art** 2814**Examiner:**

MAI, ANH D.

**Unit:****AMENDMENT AFTER FINAL REJECTION**

Hon. Commissioner of Patents and Trademarks

P. O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

*Please enter*  
*AM 6/9/05*

In response to the Office Action mailed April 4, 2005, the present application is amended as follows: